

SBM1040

10A LOW VF SCHOTTKY BARRIER RECTIFIER **POWERMITE®3**

Features

NOT RECOMMENDED FOR NEW DESIGNS -USE PDS1040

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- High Surge Capability
- High Max Junction Temperature Rating
- Low Forward Voltage Drop
- Very Low Leakage Current
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- Available in Lead Free Finish/RoHS Compliant Version (Note 2)

Mechanical Data

- Case: POWERMITE®3
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Also available in Lead Free Plating (Matte Tin Finish). Please see Ordering Information, Note 12, on Page 3
- Polarity: See Diagram
- Marking Information: See Page 3
- Weight: 0.072 grams (approximate)

Maximum Ratings @ T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

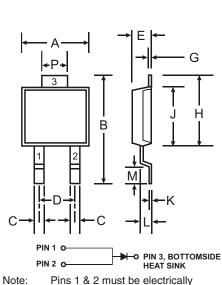
Characteristic	Symbol	Value	Unit	
ak Repetitive Reverse Voltage V _{RRM} orking Peak Reverse Voltage V _{RWM} C Blocking Voltage V _R		40	V	
RMS Reverse Voltage	V _{R(RMS)}	28	V	
Average Rectified Output Current (see also Figure 4)	lo	10	A	
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load @ $T_C = 88^{\circ}C$	I _{FSM}	150	A	
Typical Thermal Resistance Junction to Soldering Point	R _{0JS}	2.5	°C/W	
Operating Temperature Range	Tj	-65 to +150	°C	
Storage Temperature Range	T _{STG}	-65 to +150	°C	

Electrical Characteristics @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	V _{(BR)R}	40	_	_	V	I _R = 1mA
Forward Voltage	VF		0.45 0.47	0.49 0.41 0.51	V	$ I_F = 8A, T_S = 25^{\circ}C \\ I_F = 8A, T_S = 125^{\circ}C \\ I_F = 10A, T_S = 25^{\circ}C $
Reverse Current (Note 1)	IR	_	0.1 12.5	0.3 25	mA	
Total Capacitance	CT	—	700		pF	f = 1.0MHz, V _R = 4.0V DC

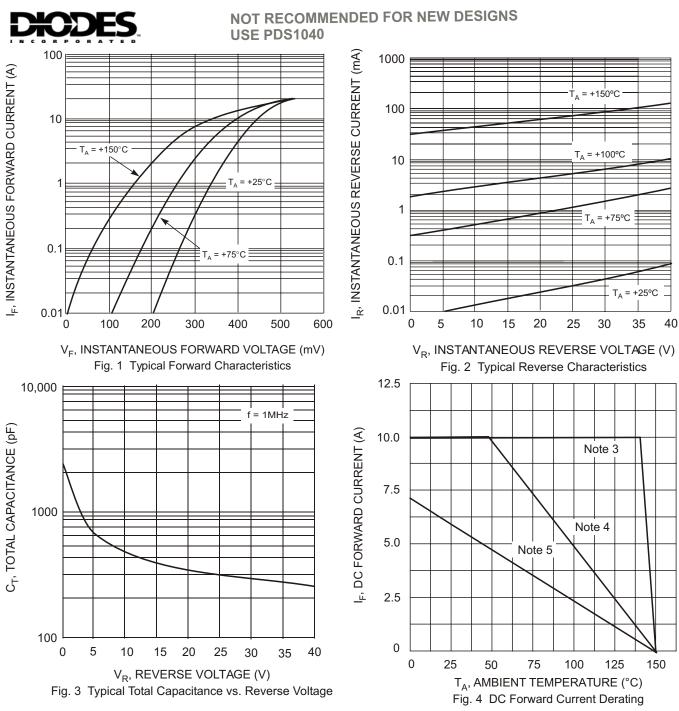
Notes: 1. Short duration test pulse used to minimize self-heating effect.

2. RoHS revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied, see EU Directive Annex Notes 5 and 7.



POWERMITE®3				
Dim	Min	Max		
Α	4.03	4.09		
В	6.40	6.61		
С	.864	.914		
D	1.83 NOM			
Е	1.10	1.14		
G	.173	.203		
Н	5.01	5.17		
J	4.37	4.43		
к	.173	.203		
L	.71	.77		
М	.36	.46		
Р	1.73	1.83		
All Dimensions in mm				

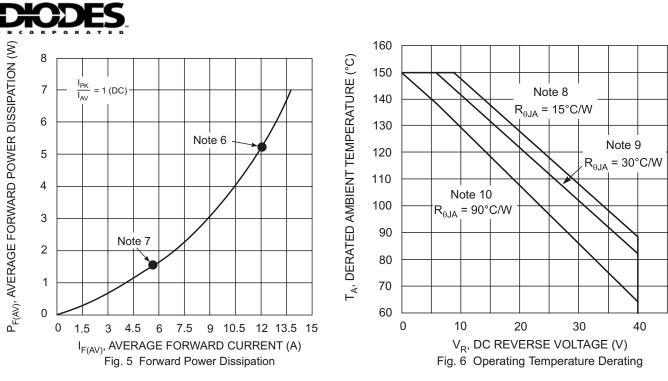
Pins 1 & 2 must be electrically connected at the printed circuit board.



Notes: 3. TA = TSOLDERING POINT, $R_{\theta JS} = 2.5^{\circ}C/W$, $R_{\theta SA} = 0^{\circ}C/W$.

Device mounted on GETEK substrate, 2"x2", 2 oz. copper, double-sided, cathode pad dimensions 0.75" x 1.0", anode pad dimensions 0.25" x 1.0". R_{0JA} in range of 15-30°C/W.

 Device mounted on FR-4 substrate, 2"x2", 2 oz. copper, single-sided, pad layout as per Diodes Inc. suggested pad layout document AP02001 which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. R_{0JA} in range of 60-75°C/W.



- Notes: 6. Maximum power dissipation when device mounted on GETEK substrate, 2"x2", 2 oz. copper, double-sided, cathode pad dimensions 0.75" x 1.0", anode pad dimensions 0.25" x 1.0". R_{0JA} in range of 15-30°C/W.
 - Maximum power dissipation when device mounted on FR-4 substrate, 2"x2", 2 oz. copper, single-sided, pad layout as per Diodes Inc. suggested pad layout document AP02001 which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. R_{0JA} in range of 60-75°C/W.
 - 8. $R_{0JA} = 15^{\circ}$ C/W when mounted on 2"x2", single-sided, ceramic board with cathode pad dimensions 0.75"x1.0", anode pad dimensions 0.25"x1.0".
 - R_{0JA} = 30°C/W when mounted on 2"x2", single-sided, FR-4 board with cathode pad dimensions 0.5"x1.0", anode pad dimensions 0.5"x1.0", 2 oz. copper pads.
 - 10. R_{θJA} = 90°C/W when mounted on 0.5"x0.625", single-sided, FR-4 board with minimum recommended pad layout.

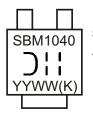
Ordering Information (Note 11)

Device	Packaging	Shipping
SBM1040-13	POWERMITE®3	5000/Tape & Reel

Notes: 11. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

12. For Lead Free Finish/RoHS Compliant version part number, please add "-F" suffix to the part number above. Example: SBM1040-13-F.

Marking Information



SBM1040 = Product type marking code)!! = Manufacturers' code marking YYWW = Date code marking YY = Last two digits of year ex: 02 for 2002 WW = Week code 01 to 52 (K) = Factory designator

NOT RECOMMENDED FOR NEW DESIGNS USE PDS1040

POWERMITE is a registered trademark of Microsemi Corporation.